Abstract: A profound understanding of the Au dissolution process is a prerequisite for optimal utilization of Au-based materials. This goes for either increasing the corrosion stability of materials in the sectors where the long-term functionality of Au is needed or decreasing the corrosion stability where the recovery of the Au component is crucial. By employing an extremely sensitive online analytical system, consisting of an electrochemical flow cell coupled to an inductively coupled plasma mass spectrometry, in situ potential-resolved dissolution of Au in the ppb range is enabled. A comparative study of two Au based materials, (i) a polycrystalline Au disk and (ii) carbon-supported Au nanoparticles, is presented. As a probe, chloride ions were used to elucidate the distinct differences in the corrosion behavior of the two analogues.

Keywords: gold; corrosion; electrochemistry; dissolution; chlorides; nanoparticles; EFC-ICP-MS

1. Introduction

Due to its nobility, gold is one of the most frequently used metals in applications where corrosion stability is needed (e.g., jewelry, electrical contacts, bio-medical applications, etc.) [1]. This is especially popular in the field of electrochemistry, namely, electrochemical sensorics [2–4] and electrocatalysis [5–15] where gold is frequently used. Furthermore, gold is also commonly used as a working or counter electrode in conventional electrochemical setups. In order to elucidate the adequacy of gold-based materials under harsh electrochemical conditions, fundamental insight into Au corrosion is urgently needed. At the same time, understanding corrosion may be of great importance in the hydrometallurgical steps of gold from end-of-life devices in the recycling process. This is of special importance in waste electrical and electronic equipment (WEEE), where Au is used in integrated circuits. Recently, also printing of gold nanoparticles has been gaining popularity [16–18]. It has been shown that these devices can fail in operation due to corrosion of Au [19]. This can be triggered by even trace amounts of halogenides,
such as chloride [20]. Overall, a profound understanding of the electrochemical dissolution of Au enabling qualitative, as well as quantitative data, was already recognized half a century ago when Au corrosion in the presence of chlorides was studied [21]. Owing to the penetration of online analytical tools for the purposes of corrosion investigations, a deeper understanding of noble material dissolution has recently been enabled [22–29]. We present an investigation of electrochemical dissolution process of polycrystalline gold in the presence of complexing chloride anions in a wide concentration range. For this purpose, well-established online analytics consisting of an electrochemical flow cell coupled to inductively coupled plasma mass spectrometry (EFC-ICP-MS) has been employed [7,28–32].

2. Materials and Methods

2.1. Au/C Synthesis

Gold nanoparticles on carbon were prepared by dissolving 0.3 mmol of hydrogen tetrachloroaurate(III) hydrate (abcr GmbH, Karlsruhe, Germany) and 0.45 mmol of citric acid (Sigma-Aldrich, St. Louis, MO, USA) in 0.6 mL of water. The solution was then mixed with 0.15 g of carbon black (VULCAN XC72R, Cabot Corporation, Alpharetta, GA, USA) at 50 °C until evaporation. Afterward, the mixture was thermally treated in 5% H2/Ar mixture. The temperature was increased with a rate of 5 °C·min⁻¹ to 500 °C for 3 h. Then the sample was cooled to room temperature with a rate of 3 °C·min⁻¹. After thermal treatment the sample contained 30 wt % of gold nanoparticles.

2.2. Transmission Electron Microscopy

Au nanoparticles were analyzed by scanning transmission electron microscopy (STEM, JEOL Ltd., Tokyo, Japan). A JEOL ARM CF operated at 80 kV was used.

2.3. Electrochemical Measurements

The first set of experiments was performed in a conventional three-electrode glass cell. All the electrodes were placed in the same compartment. Either (1) Au disk electrode (d = 3 mm) or (2) glassy carbon electrode (GC, d = 5 mm) coated with Au nanoparticles (Au/C) were used as a working electrode, Pt rod as a counter electrode and Ag/AgCl as a reference electrode. Au/C was synthesized as described above; 20 µL of water suspension (1 mg Au/C per 1 mL water) was drop-casted on the surface of GC disk. Prior to each experiment, the electrochemical cell was boiled in Milli-Q water for 1 h, and the electrode was polished to mirror finish with Al2O3 paste (particle size 0.05 µm, Buehler, Lake Bluff, IL, USA) on a polishing cloth (Buehler). After polishing, the electrodes were rinsed and ultrasonicated (Ultrasound bath Iskra Sonis 4, Iskra Pio Ltd., Šentjernej, Slovenia) in Milli-Q water for 5 min. Electrochemical experiments were performed under ambient conditions. Different amounts of HCl were added to the electrolyte in order to prepare 10⁻⁶, 10⁻⁵, 10⁻⁴, 10⁻³ and 10⁻² M solutions of Cl⁻ in 0.05 mol·L⁻¹ H2SO4.

A second set of electrochemical experiments was conducted in an electrochemical flow cell which was coupled with an ICP-MS setup (EFC-ICP-MS) already introduced in our previous publications [7,28–32]. Shortly, commercial BASi electrochemical flow cell (Cross-Flow Cell Kit MW-5052) with a homemade silicon gasket of 1 mm thickness was coupled with an Agilent 7500ce ICP-MS instrument (Agilent Technologies, Palo Alto, CA, USA) equipped with a MicroMist glass concentric nebulizer and a Peltiercooled Scott-type double-pass quartz spray chamber. A forward radio frequency power of 1500 W was used with Ar gas flows: carrier 0.85 L·min⁻¹, makeup 0.28 L·min⁻¹, plasma 1 L·min⁻¹, and cooling 15 L·min⁻¹. 0.05 mol·L⁻¹ H2SO4 (Aldrich 96%, 99.999% trace metals basis) acid was used as electrolyte carrier medium. Different amounts of HCl were added to the electrolyte in order to prepare 10⁻⁶, 10⁻⁵, 10⁻⁴ and 10⁻³ solutions of Cl⁻ in 0.05 mol·L⁻¹ H2SO4. Solutions were pumped through the electrochemical
cell at 150 µL·min⁻¹ using a syringe pump (WPI sp100i, World Precision Instruments, Sarasota, FL, USA). The electrochemical cell is based on a three-electrode configuration setup. Two cases were investigated: (1) the working electrode consisted of two Au polycrystalline disks (d = 3 mm) and (2) of two glassy carbon disks (3 mm in diameter). In each case, one of them was modified by drop-casting a suspension of Au nanoparticles supported on carbon (Au/C). Stainless steel housing was used as the counter electrode and Ag/AgCl was used as a reference electrode.

In both electrochemical cells (conventional glass cell and electrochemical flow cell) electrochemical treatment consisted of 200 cyclovoltammetry cleaning cycles between 0.05–1.2 V (300 mV·s⁻¹) followed by slow potentiodynamic (20 mV·s⁻¹) sequences by gradually increasing the upper potential limit (UPL). The highest UPL in this work was set to 1.6 V vs RHE in order to avoid the formation of oxygen bubbles due to oxygen evolution reaction (OER) or the oxidation of GC electrodes in the case of Au nanoparticles. Au real surface area was estimated by integrating the charge under the voltammetric profile in a cathodic direction in an EFC configuration (Au oxide reduction). Here, the assumption was made that at the Burshtein minimum, the electrode is covered by one monolayer of adsorbed oxygen with a transferred charge of 400 µC·cm⁻². Although this is not completely accurate, it is still a good approximation that enables us to compare two samples. All potentials are referred to reversible hydrogen electrode (RHE).

3. Results

3.1. Structural Characterization of Au/C Nanoparticles Composite

The majority of the particles exhibited an irregular shape, and mostly a size range below 5 nm (Figure 1a). The irregular shape of the particles can be described as sharp shattered crystallites that are well distributed on the carbon support. In addition, some very small clusters were also present, as can be observed in Figure 1a. However, the platonic polyhedral shapes, commonly observed in noble metal crystals, were also observed in the analyzed Au nanoparticles, ranging in size from 10 to 15 nm. In Figure 2a, a truncated icosahedron is shown displaying planes with an interplanar distance of 2.3 Å corresponding to {111} lattice planes of Au. Therefore this sample can be considered as a typical representative of gold nanoparticles.

![Figure 1](image-url)

**Figure 1.** Scanning transmission electron microscope (STEM) high-angle annular dark field images of gold nanoparticles: (a) Irregular shape; (b) Polyhedral shape (truncated icosahedron).
We note that some discrepancies of cyclic voltammograms (CV) of gold electrodes are expected. This is due to different electrode preparation [35,36] that influences grain size, surface morphology, purity. Furthermore different polishing and cleaning and electrochemical activation procedures can lead to different cyclovoltammetry profiles as well. These can be described following the established mechanism of Au oxidation [37–39]. Namely, in the positive going sweep below 1.2 V vs. RHE, the surface of gold is covered by adsorbed supporting electrolyte anions (labeled as feature A1 in Figure 2a) whereas the coverage with hydroxo species on the other hand is relatively low. Above 1.2 V vs. RHE the adsorbed anions of the supporting electrolyte are getting displaced by adsorbed OH and O species (labeled as feature A2 in Figure 2a). At higher potentials, the formation of bulk oxide/hydroxide or hydrous oxide film takes place (labeled as feature A3 in Figure 2a) via the so-called place-exchange phenomena, that is, incorporation of O into the sub-surface layers [40]. Gold “oxide” film is electrochemically reduced in the cathodic scan (labeled as feature C1 in Figure 2a).

**3.2. Electrochemical Dissolution of Polycrystalline Au Disk**

**3.2.1. Dissolution of Polycrystalline Au Disk in the Absence of Chlorides**

A series of cyclovoltammetry potential sweeps with increasing UPL and a scan rate of 20 mV·s⁻¹ was applied to the gold electrode in a conventional rotating disc electrode (RDE) configuration in the absence and presence of chloride impurities. Characteristic Au redox features frequently referred to as a fingerprint, are visible (Figure 2a). These characteristics are similar to those described in the literature [21,27,33,34]. We note that some discrepancies of cyclic voltammograms (CV) of gold electrodes are expected. This is due to different electrode preparation [35,36] that influences grain size, surface morphology, purity. Furthermore different polishing and cleaning and electrochemical activation procedures can lead to different cyclovoltammetry profiles as well. These can be described following the established mechanism of Au oxidation [37–39]. Namely, in the positive going sweep below 1.2 V vs. RHE, the surface of gold is covered by adsorbed supporting electrolyte anions (labeled as feature A1 in Figure 2a) whereas the coverage with hydroxo species on the other hand is relatively low. Above 1.2 V vs. RHE the adsorbed anions of the supporting electrolyte are getting displaced by adsorbed OH and O species (labeled as feature A2 in Figure 2a). At higher potentials, the formation of bulk oxide/hydroxide or hydrous oxide film takes place (labeled as feature A3 in Figure 2a) via the so-called place-exchange phenomena, that is, incorporation of O into the sub-surface layers [40]. Gold “oxide” film is electrochemically reduced in the cathodic scan (labeled as feature C1 in Figure 2a).
More insights into electrochemical behavior is provided by combining the cyclovoltammetry and online dissolution profiles of Au. This is achieved by combining the so-called electrochemical flow cell with inductively coupled plasma mass spectrometry analytics (EFC-ICP-MS) \cite{30,31,41,42}. This approach is especially appropriate to study such corrosion phenomena as it allows one to synchronize dissolution and current signal with the potential ramp (Figure 2d). In general potentiodynamically induced dissolution of noble metals can be described as transient phenomena \cite{24,26,42,43}. Dissolution profiles, therefore, consist of anodic and cathodic counterparts. In the former, the dissolution is triggered by the formation of surface/subsurface oxides as indicated in Figure 3b,c where dissolution coincides well with the region of Au surface oxidation (A3) onset \cite{23,27}. In the cathodic scan, reduction of the oxide is governing Au dissolution. In this case corrosion of metals is ascribed to the exclusion of oxide ions during reduction of oxides \cite{24,44}. Both dissolution counterparts are clearly resolved when UPL of 1.6 V is reached, namely the less substantial anodic dissolution peak and dominating cathodic dissolution peak (Figure 2d).

However, it has been shown that when Au is exposed to higher UPLs the anodic dissolution becomes the predominant component, whereas cathodic dissolution does not increase substantially \cite{23,27,45}. In the case of UPLs used in this study, cathodic dissolution is the predominant dissolution counterpart, which is in line with several works on highly sensible dissolution measurements of Au \cite{23,27,45,46}. Although the predominant dissolution is transient, thermodynamic reactions still found in Fourbaix diagrams are in place (see below).

\begin{equation}
2\text{Au} + 3\text{H}_2\text{O} \rightarrow \text{Au}_2\text{O}_3 + 6\text{H}^+ + 6\text{e}^-; \\
E^0 = 1.457 + 0.0591 \log [\text{H}^+] \tag{1}
\end{equation}

\begin{equation}
\text{Au} + 3\text{H}_2\text{O} \rightarrow \text{H}_3\text{AuO}_3 + 3\text{H}^+ + 3\text{e}^-; \\
E^0 = 1.511 + 0.0591 \log [\text{H}^+] \tag{2}
\end{equation}

Figure 3. EFC-ICP-MS measurements of Au dissolution from Au polycrystalline disk in the absence (a,b) and presence of chlorides (c,d) during potentiodynamic cycles (20 mV·s$^{-1}$, 0.05–1.4 or 1.6 V$_{\text{RHE}}$); (d) Simultaneous presentation of Au dissolution profile and current signal during potentiodynamic cycling (20 mV·s$^{-1}$, 0.05–1.6 V$_{\text{RHE}}$).

Electrochemical reactions in the absence of chlorides:
Electrochemical reactions in the presence of chlorides:

\[
\text{Au} + 2\text{Cl}^- \rightarrow \text{AuCl}_2^- + \text{e}^-;
\]
\[
E^0 = 1.15 - 0.1183\log[\text{Cl}^-] + 0.0592\log[\text{AuCl}_2^-]
\]

\[
\text{Au} + 4\text{Cl}^- \rightarrow \text{AuCl}_4^- + 3\text{e}^-;
\]
\[
E^0 = 1.002 - 0.079\log[\text{Cl}^-] + 0.0197\log[\text{AuCl}_4^-]
\]

3.2.2. Dissolution of Au Polycrystalline in the Presence of Chlorides

Comparison of characteristic CV features reveals that anodic features (A1 and A2) are completely absent (Figure 3a) when the concentration of chloride is sufficiently large (≥10⁻⁴ M Cl⁻). This indicates that chlorides are covering the surface of Au, hence preventing or even shifting the formation of oxides to higher potentials. This is additionally supported by observing cathodic currents where a potential shift towards more anodic potentials corresponding to a reduction of Au oxides is clearly resolved in the presence of chlorides. Since less oxide is formed in the presence of chlorides, it results in lowered oxide reduction current in the cathodic scan (Figure 3a). The shift to anodic potentials is also in accordance with the literature, and means that lower overpotentials are needed to reduce the lesser amount of oxide [31,44]. Apart from that, chlorides are known to accelerate corrosion of Au via formation of several complexes that are thermodynamically more favored than the electrochemical dissolution of Au in the absence of chlorides (see Equations above). Therefore, an additional cathodic peak (C2) can be observed at a more negative potential on the CV of gold in the chloride-containing electrolyte, which is attributed to the re-deposition of dissolved gold species (Figure 3a) [47,48]. By increasing the concentration of chlorides, anodic current increase is clearly resolved (peak A2 and also A3 to a lesser extent in Figure 3a). The current increase is not attributed to the formation of gold oxide but due to direct gold dissolution (oxidation) into chloride complexes. Therefore, in general, observed anodic dissolution profiles in the presence of chloride impurities consist of “oxide-induced” dissolution (in the absence of chloride) and “chloride-induced” dissolution (in the presence of chlorides), where “oxide-induced” dissolution is inhibited. This is directly confirmed by the EFC-ICP-MS. Namely, a substantial increase in Au dissolution in comparison to the chloride-free electrolyte is detected already in the case of low concentrations of chlorides and low UPL (Figure 3b). Under these potentials, “oxide-induced” dissolution is significantly less intensive (Figure 3b, red curve) as a low amount of oxide is formed (see CVs in Figure 2a). In the case of higher UPL both, anodic (labeled as A) and cathodic dissolution (labeled as C) counterparts are enhanced when the concentration of chloride is less than 10⁻⁴ M (Figure 3c). In the case of both branches, more intense dissolution is expected due to the formation of soluble chloride complexes (anodic case) which can also trigger dissolution in the cathodic scan once oxides are reduced [45]. Additionally, in the cathodic counterpart, increased dissolution in the case of chlorides due to inhibited re-deposition of Au ions should be considered as well [32]. Namely, two characteristics should be taken into account: (a) the surface of the Au electrode is covered/passivated with adsorbed chloride species hence Au re-deposition is significantly obstructed causing a change in the dissolution mechanism; (b) dissolved Au species are present as chloride complexes the reduction of which is thermodynamically less favored in comparison to Au aqua complexes (see equations above), and therefore these relatively stable complexes are washed away before being reduced. A similar effect was also observed on Pt-based electrodes [32,49]. However, in the presence of 10⁻⁴ M Cl⁻ cathodic dissolution profile is significantly less intense than in the case of lower concentrations of Cl⁻ (Figure 3c). This directly confirms the inhibition of Au oxide formation in the presence of chlorides (substantially...
less “oxide-induced” dissolution). This is more clearly observed if CVs and Au dissolution profiles are simultaneously compared (Figure 3d).

3.3. Electrochemical Dissolution of Au Nanoparticles

3.3.1. Dissolution of Au Nanoparticles in the Absence of Chlorides

Dissolution in the case of metallic polycrystalline disks is expected to be different in comparison to nanoparticulate electrodes due to the so-called particle size effect [50–53]. Such findings originate especially from extensive research on Pt-based electrodes where the thermodynamic stability of the nanoparticles is increasing with their size. It is well known that with decreasing size of nanoparticles the ratio of the surface atoms at terraces to that in step edges and kinks becomes smaller. Therefore, with this decrease of the coordination number the Nernst equilibrium potential becomes more negative, which should result in a higher dissolution from surface defect sites at lower potentials [53–56]. The same EFC-ICP-MS experimental protocol as in the case of Au polycrystalline disk was performed in the case of carbon supported Au nanoparticles (Au/C). By normalizing dissolution profiles on the real Au surface area (for details see Experimental) intrinsic dissolution differences between Au nanoparticles and Au polycrystalline disc can be investigated (Figure 4a,b). A rather unusual trend is noticed as both analogues show very similar dissolution when cycling till UPL 1.4 V. Even more interesting is that when cycling until 1.6 V Au nanoparticles show much larger corrosion resistance in comparison to the Au disk (Figure 4b). According to thermodynamic predictions, a reverse trend would be expected, namely Au nanoparticles should dissolve more. However, other aspects of electrode/electrolyte interaction have to be considered as well such as the formation of surface hydroxides and oxides. These passivate the electrode surface. The passivation effect is stronger when the coordination number of surface atoms is decreased. Hence at the same potential, the surface coverage with OH increases with decreases in the particle size [57]. This should result in less intense dissolution in the case of Au nanoparticles when compared to Au disk. We again note that the dissolution under UPL in the case of Figure 4 is consisted of anodic and cathodic part. Less intensive anodic dissolution in the case of Au nanoparticles is in line with more effective passivation in the latter. However, in order to explain a trend regarding cathodic dissolution, one should take into account that Au nanoparticles are embedded in carbon support. Hence, the effective thickness of the electrode is greater than in the case of Au disk. This could change the dissolution pattern via the following two effects: (i) as mentioned above, the cathodic dissolution is partially governed by re-deposition of dissolved ions. In the case of Au nanoparticles diffusion paths of dissolved cations are longer in comparison to Au disc since nanoparticles are supported on a thin layer of high surface area carbon (approximately 1 µm thick). Therefore statistically, Au ions are more likely to re-deposit [58]. (ii) Due to the porosity of the electrode layer in the case of the Au/C analogue the concentration of dissolved Au ions within the electrode layer is probably higher than in the case of the Au disk. This can cause an oversaturation within the electrode layer sooner which would explain why anodic dissolution is less intense in the case of Au nanoparticles. Both effects (i and ii) have already been reported for Pt/C catalyst [58].

3.3.2. Dissolution of Au Nanoparticles in the Presence of Chlorides

The explanation above is further supported by investigating the dissolution of Au/C analogue in the presence of chlorides. In contrast to the observation in the case of Au disk, dissolution in the case of Au/C is not increasing with increasing concentration of chlorides (Figure 4c,d). Surprisingly, until $10^{-4}$ M Cl$^-$ Au dissolution is decreasing with increasing Cl$^-$ concentration. This proves that the passivation effect of chlorides causes less oxide-induced dissolution. Furthermore, due to the porosity of the carbon support, dissolved Au species can undergo re-deposition as mentioned above. These findings are especially
important for the corrosion protection or resistance of devices since gold nanoparticles embedded in high surface area carbon exhibit improved stability over the polycrystalline Au surface. Coupled with the fact that a much lower amount of gold is needed to cover surfaces, this should be explored in anti-corrosion coatings applications.

Figure 4. EFC-ICP-MS measurements of Au dissolution from Au nanoparticles in the absence (a,b) and presence of chlorides (c,d) during potentiodynamic cycles (20 mV·s$^{-1}$, 0.05–1.4 or 1.6 V$_{\text{RHE}}$).

4. Conclusions

An on-line and downstream analytical tool, electrochemical flow cell connected to an inductively coupled plasma mass spectrometer, was used to study dissolution of Au based materials in the presence of chlorides. A comparative study of polycrystalline and nanostructured Au-based electrodes provided for novel insights into the corrosion process. Namely, polycrystalline Au dissolution mechanism is altered once (i) the chloride concentration (>10$^{-4}$ M) and (ii) the potential are sufficiently high (<1.6 V vs. RHE). In this case, cathodic dissolution is inhibited due to the suppression of oxide-driven dissolution on account of chloride-induced passivation of the Au surface. In the case of Au nanoparticles, besides the effect of particle size also the effect of carbon support should be taken into account. More specifically, due to the higher effective thickness and porous morphology, the Au dissolution mechanism is altered and the overall dissolution decreases. Therefore, nanostructured gold should be considered as an option in anti-corrosion coating applications.


Funding: This research was funded by Slovenian Research Agency (ARRS) through Projects Z2-8161 and Z1-9165 and Project P1-0153.

Conflicts of Interest: The authors declare no conflict of interest.
References


54. Plieth, W.J. Electrochemical properties of small clusters of metal atoms and their role in surface enhanced Raman scattering. *J. Phys. Chem. 1982* 86, 3166–3170. [CrossRef]


© 2018 by the authors. Licensee MDPI, Basel, Switzerland. This article is an open access article distributed under the terms and conditions of the Creative Commons Attribution (CC BY) license (http://creativecommons.org/licenses/by/4.0/).